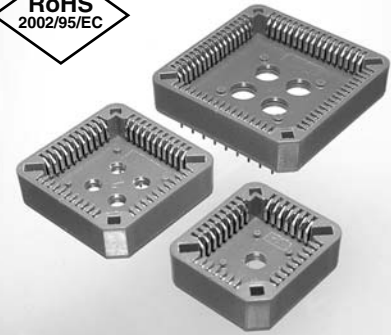


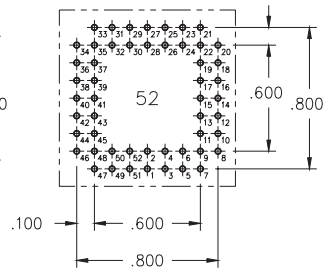
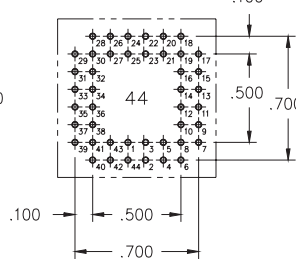
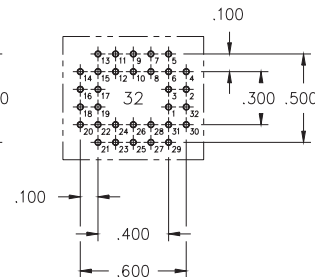
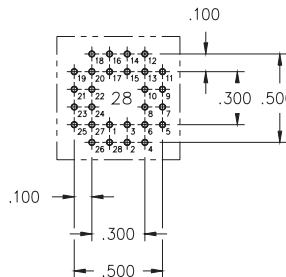
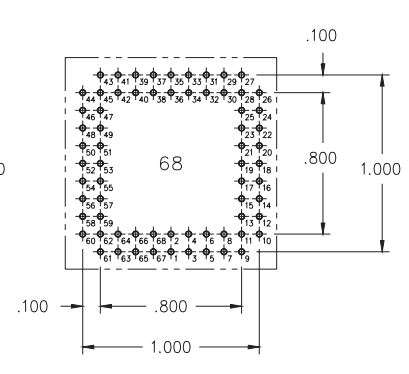
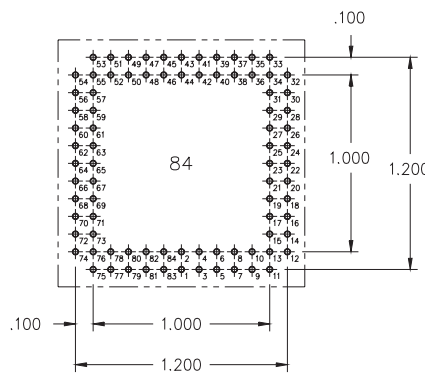
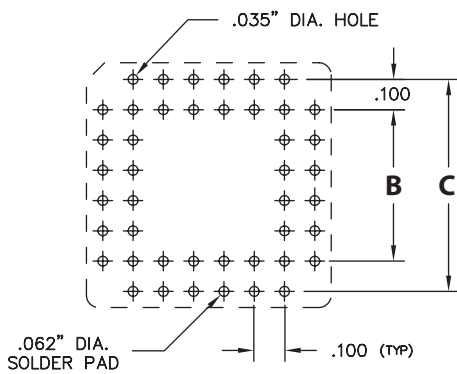
- Note: Not end stackable.
- Accepts JEDEC PLCCs MS-016 & MS-018 leaded plastic substrates.
- Internal standoffs insure proper positioning of chip carrier in socket.
- Standoffs provide clearance for heat dissipation and cleaning.
- Contacts are plated with 150 μ" tin.
- Insulator material is glass reinforced PPS.



*For Electrical,  
Mechanical & Environmental  
Data, See pg. 113*

### PRINTED CIRCUIT DRILLING PATTERNS (TOP VIEW)

.035" dia. min. mounting holes



No. of Contacts	Ordering Information	- A -	- B -	- C -	Quantity per Tube
20	940-44-020-24-000000	0.613	0.200	0.400	38
28	940-44-028-24-000000	0.713	0.300	0.500	33
32*	940-44-032-24-000000*	.813 / .713	.400 / .300	.600 / .500	29
44	940-44-044-24-000000	0.913	0.500	0.700	26
52	940-44-052-24-000000	1.013	0.600	0.800	23
68	940-44-068-24-000000	1.213	0.800	1.000	19
84	940-44-084-24-000000	1.413	1.000	1.200	16
100	940-44-100-24-000000	1.603	1.200	1.400	25

Plating Code 44 ◇ = 150μ" Sn \*RECTANGULAR